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| Type Diode | | Package Code | | ROHM Package TUMD2S (halogen free) | | Mass (mg) 5.5100 | Part No. | |
|---------------|-----------------------------------|--------------|-------------------|---------------------------------------|------------|---------------------|----------|---------|
| | | | | | | | | |
| | Mold compound | 2.1984 | Silica (amorphous | s) | 60676-86-0 | 1.6372 | 29.71% | 74.25% |
| | | | Epoxy resin I | | - | 0.2073 | 3.76% | 9.40% |
| | | | Epoxy resin II | | - | 0.0650 | 1.18% | 2.95% |
| 1 | | | Aluminum hydrox | ide | 21645-51-2 | 0.2889 | 5.24% | 13.10% |
| | | | Carbon black | | 1333-86-4 | 0.0066 | 0.12% | 0.30% |
| | | | | Subtotal | | 2.2050 | 40.02% | 100% |
| | Lead frame (Base material) | 2.8294 | Copper (Cu) | | 7440-50-8 | 2.8266 | 51.30% | 99.90% |
| 2 | | | Iron (Fe) | | 7439-89-6 | 0.0028 | 0.05% | 0.10% |
| | | | | Subtotal | | 2.8294 | 51.35% | 100% |
| ~ | Lead frame (Surface treatment) | 0.0718 | Silver (Ag) | | 7440-22-4 | 0.0718 | 1.30% | 100.00% |
| 3 | | | | Subtotal | | 0.0718 | 1.30% | 100% |
| | External plating | 0.1505 | Tin (Sn) | | 7440-31-5 | 0.1505 | 2.73% | 100.00% |
| 4 | | | | Subtotal | | 0.1505 | 2.73% | 100% |
| | Die | 0.1760 | Silicon (Si) | | 7440-21-3 | 0.1710 | 3.10% | 97.16% |
| 5 | | | Silver (Ag) | | 7440-22-4 | 0.0050 | 0.09% | 2.84% |
| | | | | Subtotal | | 0.1760 | 3.19% | 100% |
| | Die attach | 0.0691 | Silver (Ag) | | 7440-22-4 | 0.0593 | 1.08% | 85.86% |
| 6 | | | Epoxy resin | | - | 0.0080 | 0.15% | 11.59% |
| 6 | | | Phenol resin | | - | 0.0018 | 0.03% | 2.55% |
| | | | | Subtotal | | 0.0691 | 1.25% | 1009 |
| - | Bonding wire | 0.0082 | Gold (Au) | | 7440-57-5 | 0.0082 | 0.15% | 100.00% |
| 7 | | | | Subtotal | | 0.0082 | 0.15% | 100% |
| | | | | Total | - | 5.5100 | 100% | - |

| Note |
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·All information in this document is furnished for exploratory or indicative purposes only.

•This information provides estimates of the average weights and content of component materials. and does not include impurities or metals diffused in the silicon.

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